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What Are Embedded - Microcontrollers - Application Specific?

Application specific microcontrollers are engineered to

Details

Product Status	Obsolete
Applications	HB LED Controller
Core Processor	M8C
Program Memory Type	FLASH (4KB)
Controller Series	CY8CLED
RAM Size	256 x 8
Interface	I ² C, IrDA, SPI, UART/USART
Number of I/O	6
Voltage - Supply	2.4V ~ 5.25V
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8cled02-8sxi

Contents

EZ-Color™ Functional Overview	3	Packaging Information	31
Target Applications	3	Thermal Impedances	34
The PSoC Core	3	Solder Reflow Peak Temperature	34
The Digital System	3	Development Tool Selection	35
The Analog System	4	Software Tools	35
Additional System Resources	4	Hardware Tools	35
EZ-Color Device Characteristics	5	Evaluation Tools	35
Getting Started	5	Device Programmers	35
Application Notes	5	Accessories (Emulation and Programming)	36
Development Kits	5	Ordering Information	36
Training	5	Key Device Features	36
CYPros Consultants	5	Ordering Code Definitions	36
Solutions Library	5	Acronyms	37
Technical Support	5	Acronyms Used	37
Development Tools	6	Reference Documents	37
PSoC Designer Software Subsystems	6	Document Conventions	38
Designing with PSoC Designer	7	Units of Measure	38
Select User Modules	7	Numeric Conventions	38
Configure User Modules	7	Glossary	38
Organize and Connect	7	Document History Page	43
Generate, Verify, and Debug	7	Sales, Solutions, and Legal Information	44
Pin Information	8	Worldwide Sales and Design Support	44
Pinouts	8	Products	44
Register Reference	10	PSoC Solutions	44
Register Conventions	10		
Register Mapping Tables	10		
Electrical Specifications	13		
Absolute Maximum Ratings	14		
Operating Temperature	14		
DC Electrical Characteristics	15		
AC Electrical Characteristics	22		

EZ-Color™ Functional Overview

Cypress's EZ-Color family of devices offers the ideal control solution for High Brightness LED applications requiring intelligent dimming control. EZ-Color devices combine the power and flexibility of Programmable System-on-Chip (PSoC®); with Cypress' precise illumination signal modulation (PrISM™) drive technology providing lighting designers a fully customizable and integrated lighting solution platform.

The EZ-Color family supports a range of independent LED channels from 4 channels at 32 bits of resolution each, up to 16 channels at 8 bits of resolution each. This enables lighting designers the flexibility to choose the LED array size and color quality. PSoC Designer software, with lighting specific drivers, can significantly cut development time and simplify implementation of fixed color points through temperature, optical, and LED binning compensation. EZ-Color's virtually limitless analog and digital customization enables the simple integration of features in addition to intelligent lighting, such as Battery Charging, Image Stabilization, and Motor Control during the development process. These features, along with Cypress's best-in-class quality and design support, make EZ-Color the ideal choice for intelligent HB LED control applications.

Target Applications

- LCD Backlight
- Large Signs
- General Lighting
- Architectural Lighting
- Camera/Cell Phone Flash
- Flashlights

The PSoC Core

The PSoC Core is a powerful engine that supports a rich instruction set. It encompasses SRAM for data storage, an interrupt controller, sleep and watchdog timers, and an internal main oscillator (IMO) and an internal low-speed oscillator (ILO). The CPU core, called the M8C, is a powerful, four-million instructions per second (MIPS), 8-bit Harvard-architecture microprocessor with speeds up to 24 MHz.

System resources provide additional capability, such as digital clocks to increase the flexibility of the PSoC; I²C functionality for implementing an I²C master, slave, or multi-master; an internal voltage reference that provides an absolute value of 1.3 V to a number of PSoC subsystems; a switch mode pump (SMP) that generates normal operating voltages off a single battery cell; and various system resets supported by the M8C.

The digital system is composed of an array of digital blocks, which can be configured into any number of digital peripherals. The digital blocks can be connected to the GPIO through a series of global busses that can route any signal to any pin, freeing designers from the constraints of a fixed peripheral controller.

The analog system consists of four analog blocks, supporting comparators, and analog-to-digital conversion up to 10 bits of precision.

The Digital System

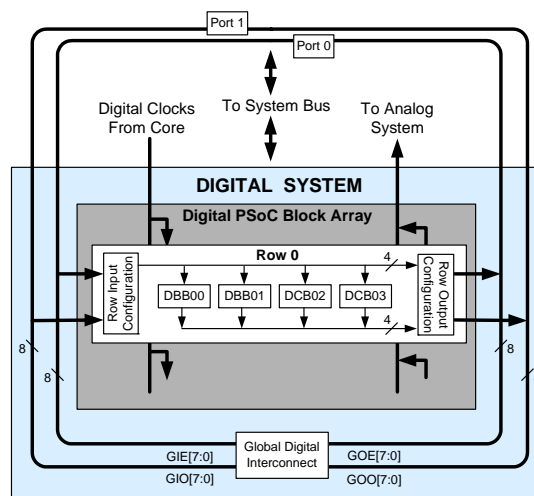
The digital system is composed of four digital PSoC blocks. Each block is an 8-bit resource that can be used alone or combined with other blocks to form 8-, 16-, 24-, and 32-bit peripherals, which are called user modules. Digital peripheral configurations include those listed below.

- PrISM (8- to 32-bit)
- PWMs (8- to 32-bit)
- PWMs with dead band (8- to 32-bit)
- Counters (8- to 32-bit)
- Timers (8- to 32-bit)
- UART 8-bit with selectable parity
- SPI master and slave
- I²C slave, master, multi-master (one available as a system resource)
- Cyclical redundancy checker (CRC)/generator (8- to 32-bit)
- IrDA (up to four)
- Generators (8- to 32-bit)

Connect the digital blocks to any GPIO through a series of global busses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Digital blocks are provided in rows of four, where the number of blocks varies by device family. This allows you the optimum choice of system resources for your application. Family resources are shown in the table titled EZ-Color Device Characteristics.

Figure 1. Digital System Block Diagram



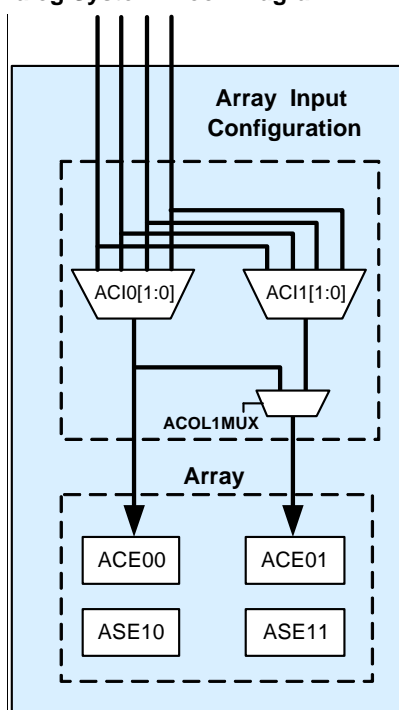
The Analog System

The analog system is composed of four configurable blocks that enable creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the more common EZ-Color analog functions (most available as user modules) are listed below.

- ADCs (single or dual, with 10-bit resolution)
- Pin-to-pin comparators (1)
- Single-ended comparators (up to two) with absolute (1.3-V) reference or 8-bit DAC reference
- 1.3-V reference (as a system resource)

In most PSoC based devices, analog blocks are provided in columns of three, which includes one continuous time (CT) and two switched capacitor (SC) blocks. This particular EZ-Color device provides limited functionality Type E analog blocks. Each column contains one CT block and one SC block.

Figure 2. Analog System Block Diagram



Additional System Resources

System resources, some of which have been previously listed, provide additional capability useful to complete systems. Additional resources include:

- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks can be generated using digital blocks as clock dividers.
- The I²C module provides 100- and 400-kHz communication over two wires. Slave, master, and multi-master modes are all supported.
- Low-voltage detect (LVD) interrupts can signal the application of falling voltage levels, while the advanced power-on reset (POR) circuit eliminates the need for a system supervisor.
- An internal 1.3-V voltage reference provides an absolute reference for the analog system, including ADCs and DACs.
- An integrated switch mode pump generates normal operating voltages from a single 1.2-V battery cell, providing a low cost boost converter.

EZ-Color Device Characteristics

Depending on your EZ-Color device characteristics, the digital, and analog systems can have 16, 8, or 4 digital blocks and 12, 6, or 4 analog blocks. The following table lists the resources available for specific EZ-Color device groups. The device covered by this data sheet is shown in the highlighted row of the table.

Table 1. EZ-Color Device Characteristics

Part Number	LED Channels	Digital I/O	Digital Rows	Digital Blocks	Analog Inputs	Analog Outputs	Analog Columns	Analog Blocks	SRAM Size	Flash Size	CapSense®
CY8CLED02	2	16	1	4	8	0	2	4	256 Bytes	4K	No
CY8CLED04	4	56	1	4	48	2	2	6	1K	16K	Yes
CY8CLED08	8	44	2	8	12	4	4	12	256 Bytes	16K	No
CY8CLED16	16	44	4	16	12	4	4	12	2K	32K	No

Getting Started

The quickest path to understanding the EZ-Color silicon is by reading this datasheet and using the PSoC Designer integrated development environment (IDE). This datasheet is an overview of the EZ-Color integrated circuit and presents specific pin, register, and electrical specifications.

For up-to-date ordering, packaging, and electrical specification information, reference the latest device datasheets on the cypress website at <http://www.cypress.com>.

Application Notes

[Cypress application notes](#) are an excellent introduction to the wide variety of possible PSoC designs.

Development Kits

[PSoC Development Kits](#) are available online from and through a growing number of regional and global distributors, which include Arrow, Avnet, Digi-Key, Farnell, Future Electronics, and Newark.

Training

[Free PSoC technical training](#) (on demand, webinars, and workshops), which is available online via www.cypress.com, covers a wide variety of topics and skill levels to assist you in your designs.

CYPros Consultants

Certified PSoC consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC consultant go to the [CYPros Consultants](#) website.

Solutions Library

Visit our growing [library of solution focused designs](#). Here you can find various application designs that include firmware and hardware design files that enable you to complete your designs quickly.

Technical Support

[Technical support](#) – including a searchable Knowledge Base articles and technical forums – is also available online. If you cannot find an answer to your question, call our Technical Support hotline at 1-800-541-4736.

Development Tools

PSoC Designer™ is the revolutionary integrated design environment (IDE) that you can use to customize PSoC to meet your specific application requirements. PSoC Designer software accelerates system design and time to market. Develop your applications using a library of precharacterized analog and digital peripherals (called user modules) in a drag-and-drop design environment. Then, customize your design by leveraging the dynamically generated application programming interface (API) libraries of code. Finally, debug and test your designs with the integrated debug environment, including in-circuit emulation and standard software debug features. PSoC Designer includes:

- Application editor graphical user interface (GUI) for device and user module configuration and dynamic reconfiguration
- Extensive user module catalog
- Integrated source-code editor (C and assembly)
- Free C compiler with no size restrictions or time limits
- Built-in debugger
- In-circuit emulation
- Built-in support for communication interfaces:
 - Hardware and software I²C slaves and masters
 - Full-speed USB 2.0
 - Up to four full-duplex universal asynchronous receiver/transmitters (UARTs), SPI master and slave, and wireless

PSoC Designer supports the entire library of PSoC 1 devices and runs on Windows XP, Windows Vista, and Windows 7.

PSoC Designer Software Subsystems

Design Entry

In the chip-level view, choose a base device to work with. Then select different onboard analog and digital components that use the PSoC blocks, which are called user modules. Examples of user modules are analog-to-digital converters (ADCs), digital-to-analog converters (DACs), amplifiers, and filters. Configure the user modules for your chosen application and connect them to each other and to the proper pins. Then generate your project. This prepopulates your project with APIs and libraries that you can use to program your application.

The tool also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic reconfiguration makes it possible to change configurations at run time. In essence, this lets you to use more than 100 percent of PSoC's resources for an application.

Code Generation Tools

The code generation tools work seamlessly within the PSoC Designer interface and have been tested with a full range of debugging tools. You can develop your design in C, assembly, or a combination of the two.

Assemblers. The assemblers allow you to merge assembly code seamlessly with C code. Link libraries automatically use absolute addressing or are compiled in relative mode, and linked with other software modules to get absolute addressing.

C Language Compilers. C language compilers are available that support the PSoC family of devices. The products allow you to create complete C programs for the PSoC family devices. The optimizing C compilers provide all of the features of C, tailored to the PSoC architecture. They come complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

Debugger

PSoC Designer has a debug environment that provides hardware in-circuit emulation, allowing you to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow you to read and program and read and write data memory, and read and write I/O registers. You can read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also lets you to create a trace buffer of registers and memory locations of interest.

Online Help System

The online help system displays online, context-sensitive help. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an Online Support Forum to aid the designer.

In-Circuit Emulator

A low-cost, high-functionality in-circuit emulator (ICE) is available for development support. This hardware can program single devices.

The emulator consists of a base unit that connects to the PC using a USB port. The base unit is universal and operates with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full-speed (24 MHz) operation.

Table 7. Register Map Bank 1: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW		40		ASE10CR0	80	RW		C0	
PRT0DM1	01	RW		41			81			C1	
PRT0IC0	02	RW		42			82			C2	
PRT0IC1	03	RW		43			83			C3	
PRT1DM0	04	RW		44		ASE11CR0	84	RW		C4	
PRT1DM1	05	RW		45			85			C5	
PRT1IC0	06	RW		46			86			C6	
PRT1IC1	07	RW		47			87			C7	
	08			48			88			C8	
	09			49			89			C9	
	0A			4A			8A			CA	
	0B			4B			8B			CB	
	0C			4C			8C			CC	
	0D			4D			8D			CD	
	0E			4E			8E			CE	
	0F			4F			8F			CF	
	10			50			90		GDI_O_IN	D0	RW
	11			51			91		GDI_E_IN	D1	RW
	12			52			92		GDI_O_OU	D2	RW
	13			53			93		GDI_E_OU	D3	RW
	14			54			94			D4	
	15			55			95			D5	
	16			56			96			D6	
	17			57			97			D7	
	18			58			98			D8	
	19			59			99			D9	
	1A			5A			9A			DA	
	1B			5B			9B			DB	
	1C			5C			9C			DC	
	1D			5D			9D		OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBB00FN	20	RW	CLK_CR0	60	RW		A0		OSC_CR0	E0	RW
DBB00IN	21	RW	CLK_CR1	61	RW		A1		OSC_CR1	E1	RW
DBB00OU	22	RW	ABF_CR0	62	RW		A2		OSC_CR2	E2	RW
	23		AMD_CR0	63	RW		A3		VLT_CR	E3	RW
DBB01FN	24	RW	CMP_GO_EN	64	RW		A4		VLT_CMP	E4	R
DBB01IN	25	RW		65			A5		ADC0_TR	E5	RW
DBB01OU	26	RW	AMD_CR1	66	RW		A6		ADC1_TR	E6	RW
	27		ALT_CR0	67	RW		A7			E7	
DCB02FN	28	RW		68			A8		IMO_TR	E8	W
DCB02IN	29	RW		69			A9		ILO_TR	E9	W
DCB02OU	2A	RW		6A			AA		BDG_TR	EA	RW
	2B		CLK_CR3	6B	RW		AB		ECO_TR	EB	W
DCB03FN	2C	RW	TMP_DR0	6C	RW		AC			EC	
DCB03IN	2D	RW	TMP_DR1	6D	RW		AD			ED	
DCB03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
	2F		TMP_DR3	6F	RW		AF			EF	
	30			70		RDI0RI	B0	RW		F0	
	31			71		RDI0SYN	B1	RW		F1	
	32		ACE00CR1	72	RW	RDI0IS	B2	RW		F2	
	33		ACE00CR2	73	RW	RDI0LT0	B3	RW		F3	
	34			74		RDI0LT1	B4	RW		F4	
	35			75		RDI0RO0	B5	RW		F5	
	36		ACE01CR1	76	RW	RDI0RO1	B6	RW		F6	
	37		ACE01CR2	77	RW		B7		CPU_F	F7	RL
	38			78			B8			F8	
	39			79			B9			F9	
	3A			7A			BA		FLS_PR1	FA	RW
	3B			7B			BB			FB	
	3C			7C			BC			FC	
	3D			7D			BD			FD	
	3E			7E			BE		CPU_SCR1	FE	#
	3F			7F			BF		CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

Absolute Maximum Ratings

Table 8. Absolute Maximum Ratings

Symbol	Description	Min	Typ	Max	Units	Notes
T _{STG}	Storage temperature	–55	25	+100	°C	Higher storage temperatures reduce data retention time. Recommended storage temperature is +25 °C ± 25 °C. Extended duration storage temperatures above 65 °C degrade reliability.
T _{BAKETEMP}	Bake temperature	–	125	See package label	°C	
T _{BAKETIME}	Bake Time	See package label	–	72	Hours	
T _A	Ambient temperature with power applied	–40	–	+85	°C	
V _{DD}	Supply voltage on V _{DD} relative to V _{SS}	–0.5	–	+6.0	V	
V _{IO}	DC input voltage	V _{SS} – 0.5	–	V _{DD} + 0.5	V	
V _{IOZ}	DC voltage applied to tri-state	V _{SS} – 0.5	–	V _{DD} + 0.5	V	
I _{MIO}	Maximum current into any port pin	–25	–	+50	mA	
ESD	Electrostatic discharge voltage	2000	–	–	V	Human Body Model ESD.
LU	Latch up current	–	–	200	mA	

Operating Temperature

Table 9. Operating Temperature

Symbol	Description	Min	Typ	Max	Units	Notes
T _A	Ambient temperature	–40	–	+85	°C	
T _J	Junction temperature	–40	–	+100	°C	The temperature rise from ambient to junction is package specific. See Thermal Impedances on page 34 . You must limit the power consumption to comply with this requirement.

DC General Purpose I/O Specifications

Table 11 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters are measured at 5 V, 3.3 V, or 2.7 V at 25°C and are for design guidance only.

Table 11. 5-V and 3.3-V DC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R_{PU}	Pull-up resistor	4	5.6	8	$k\Omega$	
R_{PD}	Pull-down resistor	4	5.6	8	$k\Omega$	
V_{OH}	High output level	$V_{DD} - 1.0$	–	–	V	$I_{OH} = 10\text{ mA}$, $V_{DD} = 4.75\text{ to }5.25\text{ V}$ (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 80 mA maximum combined I_{OH} budget.
V_{OL}	Low output level	–	–	0.75	V	$I_{OL} = 25\text{ mA}$, $V_{DD} = 4.75\text{ to }5.25\text{ V}$ (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 150 mA maximum combined I_{OL} budget.
I_{OH}	High level source current	10	–	–	mA	$V_{OH} = V_{DD} - 1.0\text{ V}$. See the limitations of the total current in the Note for V_{OH} .
I_{OL}	Low level sink current	25	–	–	mA	$V_{OL} = 0.75\text{ V}$. See the limitations of the total current in the Note for V_{OL} .
V_{IL}	Input low level	–	–	0.8	V	$V_{DD} = 3.0\text{ to }5.25$.
V_{IH}	Input high level	2.1	–	–	V	$V_{DD} = 3.0\text{ to }5.25$.
V_H	Input hysteresis	–	60	–	mV	
I_{IL}	Input leakage (absolute value)	–	1	–	nA	Gross tested to $1\text{ }\mu\text{A}$.
C_{IN}	Capacitive load on pins as input	–	3.5	10	pF	Package and pin dependent. Temp = 25°C .
C_{OUT}	Capacitive load on pins as output	–	3.5	10	pF	Package and pin dependent. Temp = 25°C .

Table 12 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 2.4 V to 3.0 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$. Typical parameters are measured at 2.7 V at 25 °C and are for design guidance only.

Table 12. 2.7-V DC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R_{PU}	Pull-up resistor	4	5.6	8	$k\Omega$	
R_{PD}	Pull-down resistor	4	5.6	8	$k\Omega$	
V_{OH}	High output level	$V_{DD} - 0.4$	–	–	V	$I_{OH} = 2.5\text{ mA}$ (6.25 typical), $V_{DD} = 2.4$ to 3.0 V (16 mA maximum, 50 mA typical combined I_{OH} budget).
V_{OL}	Low output level	–	–	0.75	V	$I_{OL} = 10\text{ mA}$, $V_{DD} = 2.4$ to 3.0 V (90 mA maximum combined I_{OL} budget).
I_{OH}	High level source current	2.5	–	–	mA	$V_{OH} = V_{DD} - 0.4\text{ V}$. See the limitations of the total current in the Note for V_{OH} .
I_{OL}	Low Level Sink Current	10	–	–	mA	$V_{OL} = 0.75\text{ V}$. See the limitations of the total current in the Note for V_{OL} .
V_{IL}	Input low level	–	–	0.75	V	$V_{DD} = 2.4$ to 3.0.
V_{IH}	Input high level	2.0	–	–	V	$V_{DD} = 2.4$ to 3.0.
V_H	Input hysteresis	–	60	–	mV	
I_{IL}	Input leakage (absolute value)	–	1	–	nA	Gross tested to 1 μA .
C_{IN}	Capacitive load on pins as input	–	3.5	10	pF	Package and pin dependent. Temp = 25 °C.
C_{OUT}	Capacitive load on pins as output	–	3.5	10	pF	Package and pin dependent. Temp = 25 °C.

DC Amplifier Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, 3.0 V to 3.6 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 2.4 V to 3.0 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters are measured at 5 V, 3.3 V, or 2.7 V at 25 °C and are for design guidance only.

Table 13. 5-V DC Amplifier Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{OSOA}	Input offset voltage (absolute value)	–	2.5	15	mV	
TCV_{OSOA}	Average input offset voltage drift	–	10	–	$\mu\text{V}/^{\circ}\text{C}$	
I_{EBOA}	Input leakage current (Port 0 analog pins)	–	200	–	pA	Gross tested to 1 μA .
C_{INOA}	Input capacitance (Port 0 analog pins)	–	4.5	9.5	pF	Package and pin dependent. Temp = 25 °C.
V_{CMOA}	Common mode voltage range	0.0	–	$V_{DD} - 1$	V	
G_{OLOA}	Open loop gain	80	–	–	dB	
I_{SOA}	Amplifier supply current	–	10	30	μA	

Table 14. 3.3-V DC Amplifier Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{OSOA}	Input offset voltage (absolute value)	–	2.5	15	mV	
TCV_{OSOA}	Average input offset voltage drift	–	10	–	$\mu V/^{\circ}C$	
I_{EBOA}	Input leakage current (Port 0 analog pins)	–	200	–	pA	Gross tested to 1 μA .
C_{INOA}	Input capacitance (Port 0 analog pins)	–	4.5	9.5	pF	Package and pin dependent. Temp = 25 $^{\circ}C$.
V_{CMOA}	Common mode voltage range	0	–	$V_{DD} - 1$	V	
G_{OLOA}	Open loop gain	80	–	–	dB	
I_{SOA}	Amplifier supply current	–	10	30	μA	

Table 15. 2.7-V DC Amplifier Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{OSOA}	Input offset voltage (absolute value)	–	2.5	15	mV	
TCV_{OSOA}	Average input offset voltage drift	–	10	–	$\mu V/^{\circ}C$	
I_{EBOA}	Input leakage current (Port 0 analog pins)	–	200	–	pA	Gross tested to 1 μA .
C_{INOA}	Input capacitance (Port 0 analog pins)	–	4.5	9.5	pF	Package and pin dependent. Temp = 25 $^{\circ}C$.
V_{CMOA}	Common mode voltage range	0	–	$V_{DD} - 1$	V	
G_{OLOA}	Open loop gain	80	–	–	dB	
I_{SOA}	Amplifier supply current	–	10	30	μA	

DC Low Power Comparator Specifications

Table 16 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}C \leq T_A \leq 85^{\circ}C$, 3.0 V to 3.6 V and $-40^{\circ}C \leq T_A \leq 85^{\circ}C$, or 2.4 V to 3.0 V and $-40^{\circ}C \leq T_A \leq 85^{\circ}C$, respectively. Typical parameters are measured at 5 V at 25 $^{\circ}C$ and are for design guidance only.

Table 16. DC Low Power Comparator Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{REFLPC}	Low power comparator (LPC) reference voltage range	0.2	–	$V_{DD} - 1$	V	
I_{SLPC}	LPC supply current	–	10	40	μA	
V_{OSLPC}	LPC voltage offset	–	2.5	30	mV	

DC Switch Mode Pump Specifications

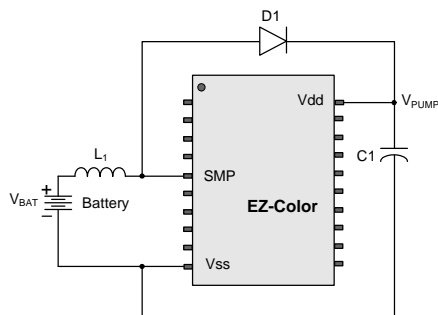
Table 17 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 2.4 V to 3.0 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters are measured at 5 V, 3.3 V, or 2.7 V at 25°C and are for design guidance only.

Table 17. DC Switch Mode Pump (SMP) Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{PUMP5V}	5 V output voltage from pump	4.75	5.0	5.25	V	Configured as in Note 3 . Average, neglecting ripple. SMP trip voltage is set to 5.0 V.
V_{PUMP3V}	3.3 V output voltage from pump	3.00	3.25	3.60	V	Configured as in Note 3 . Average, neglecting ripple. SMP trip voltage is set to 3.25 V.
V_{PUMP2V}	2.6 V output voltage from pump	2.45	2.55	2.80	V	Configured as in Note 3 . Average, neglecting ripple. SMP trip voltage is set to 2.55 V.
I_{PUMP}	Available output current $V_{\text{BAT}} = 1.8 \text{ V}$, $V_{\text{PUMP}} = 5.0 \text{ V}$ $V_{\text{BAT}} = 1.5 \text{ V}$, $V_{\text{PUMP}} = 3.25 \text{ V}$ $V_{\text{BAT}} = 1.3 \text{ V}$, $V_{\text{PUMP}} = 2.55 \text{ V}$	5 8 8	— — —	— — —	mA mA mA	Configured as in Note 3 . SMP trip voltage is set to 5.0 V. SMP trip voltage is set to 3.25 V. SMP trip voltage is set to 2.55 V.
V_{BAT5V}	Input voltage range from battery	1.8	—	5.0	V	Configured as in Note 3 . SMP trip voltage is set to 5.0 V.
V_{BAT3V}	Input voltage range from battery	1.0	—	3.3	V	Configured as in Note 3 . SMP trip voltage is set to 3.25 V.
V_{BAT2V}	Input voltage range from battery	1.0	—	2.8	V	Configured as in Note 3 . SMP trip voltage is set to 2.55 V.
V_{BATSTART}	Minimum input voltage from battery to start pump	1.2	—	—	V	Configured as in Note 3 . $0^{\circ}\text{C} \leq T_A \leq 100^{\circ}\text{C}$. 1.25 V at $T_A = -40^{\circ}\text{C}$.
$\Delta V_{\text{PUMP_Line}}$	Line regulation (over V_i range)	—	5	—	% V_O	Configured as in Note 3 . V_O is the “ V_{DD} Value for PUMP Trip” specified by the VM[2:0] setting in the DC POR and LVD Specification, Table 18 on page 20 .
$\Delta V_{\text{PUMP_Load}}$	Load Regulation	—	5	—	% V_O	Configured as in Note 3 . V_O is the “ V_{DD} Value for PUMP Trip” specified by the VM[2:0] setting in the DC POR and LVD Specification, Table 18 on page 20 .
$\Delta V_{\text{PUMP_Ripple}}$	Output voltage ripple (depends on cap/load)	—	100	—	mVpp	Configured as in Note 3 . Load is 5 mA.
E_3	Efficiency	35	50	—	%	Configured as in Note 3 . Load is 5 mA. SMP trip voltage is set to 3.25 V.
E_2	Efficiency	35	80	—	%	For $I_{\text{load}} = 1 \text{ mA}$, $V_{\text{PUMP}} = 2.55 \text{ V}$, $V_{\text{BAT}} = 1.3 \text{ V}$, 10 μH inductor, 1 μF capacitor, and Schottky diode.
F_{PUMP}	Switching frequency	—	1.3	—	MHz	
DC_{PUMP}	Switching duty cycle	—	50	—	%	

Note

3. $L_1 = 2 \text{ mH}$ inductor, $C_1 = 10 \text{ mF}$ capacitor, $D_1 = \text{Schottky diode}$. See [Figure 7](#) on page 20.

Figure 7. Basic Switch Mode Pump Circuit


DC POR and LVD Specifications

Table 18 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 2.4 V to 3.0 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters are measured at 5 V, 3.3 V, or 2.7 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 18. DC POR and LVD Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{PPOR0}	V_{DD} value for PPOR trip PORLEV[1:0] = 00b	—	2.36	2.40	V	V_{DD} must be greater than or equal to 2.5 V during startup, reset from the XRES pin, or reset from Watchdog.
V_{PPOR1}	PORLEV[1:0] = 01b		2.82	2.95	V	
V_{PPOR2}	PORLEV[1:0] = 10b		4.55	4.70	V	
V_{LVD0}	V_{DD} value for LVD trip VM[2:0] = 000b	2.40	2.45	2.51 ^[4]	V	
V_{LVD1}	VM[2:0] = 001b	2.85	2.92	2.99 ^[5]	V	
V_{LVD2}	VM[2:0] = 010b	2.95	3.02	3.09	V	
V_{LVD3}	VM[2:0] = 011b	3.06	3.13	3.20	V	
V_{LVD4}	VM[2:0] = 100b	4.37	4.48	4.55	V	
V_{LVD5}	VM[2:0] = 101b	4.50	4.64	4.75	V	
V_{LVD6}	VM[2:0] = 110b	4.62	4.73	4.83	V	
V_{LVD7}	VM[2:0] = 111b	4.71	4.81	4.95	V	
V_{PUMP0}	V_{DD} value for PUMP trip VM[2:0] = 000b	2.45	2.55	2.62 ^[6]	V	
V_{PUMP1}	VM[2:0] = 001b	2.96	3.02	3.09	V	
V_{PUMP2}	VM[2:0] = 010b	3.03	3.10	3.16	V	
V_{PUMP3}	VM[2:0] = 011b	3.18	3.25	3.32 ^[7]	V	
V_{PUMP4}	VM[2:0] = 100b	4.54	4.64	4.74	V	
V_{PUMP5}	VM[2:0] = 101b	4.62	4.73	4.83	V	
V_{PUMP6}	VM[2:0] = 110b	4.71	4.82	4.92	V	
V_{PUMP7}	VM[2:0] = 111b	4.89	5.00	5.12	V	

Notes

4. Always greater than 50 mV above PPOR (PORLEV = 00) for falling supply.
5. Always greater than 50 mV above PPOR (PORLEV = 10) for falling supply.
6. Always greater than 50 mV above V_{LVD0} .
7. Always greater than 50 mV above V_{LVD3} .

AC GPIO Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, 3.0 V to 3.6 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 2.4 V to 3.0 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters are measured at 5 V, 3.3 V, or 2.7 V at 25 $^{\circ}\text{C}$ and are for design guidance only.

Table 23. 5-V and 3.3-V AC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO operating frequency	0	–	12	MHz	Normal strong mode
TRiseF	Rise time, normal strong mode, $\text{Cload} = 50\text{ pF}$	3	–	18	ns	$V_{\text{DD}} = 4.5\text{ to }5.25\text{ V}$, 10% - 90%
TFallF	Fall time, normal strong mode, $\text{Cload} = 50\text{ pF}$	2	–	18	ns	$V_{\text{DD}} = 4.5\text{ to }5.25\text{ V}$, 10% - 90%
TRiseS	Rise time, slow strong mode, $\text{Cload} = 50\text{ pF}$	10	27	–	ns	$V_{\text{DD}} = 3\text{ to }5.25\text{ V}$, 10% - 90%
TFallS	Fall time, slow strong mode, $\text{Cload} = 50\text{ pF}$	10	22	–	ns	$V_{\text{DD}} = 3\text{ to }5.25\text{ V}$, 10% - 90%

Table 24. 2.7-V AC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO operating frequency	0	–	3	MHz	Normal strong mode
TRiseF	Rise time, normal strong mode, $\text{Cload} = 50\text{ pF}$	6	–	50	ns	$V_{\text{DD}} = 2.4\text{ to }3.0\text{ V}$, 10% - 90%
TFallF	Fall time, normal strong mode, $\text{Cload} = 50\text{ pF}$	6	–	50	ns	$V_{\text{DD}} = 2.4\text{ to }3.0\text{ V}$, 10% - 90%
TRiseS	Rise time, slow strong mode, $\text{Cload} = 50\text{ pF}$	18	40	120	ns	$V_{\text{DD}} = 2.4\text{ to }3.0\text{ V}$, 10% - 90%
TFallS	Fall time, slow strong mode, $\text{Cload} = 50\text{ pF}$	18	40	120	ns	$V_{\text{DD}} = 2.4\text{ to }3.0\text{ V}$, 10% - 90%

Figure 8. GPIO Timing Diagram

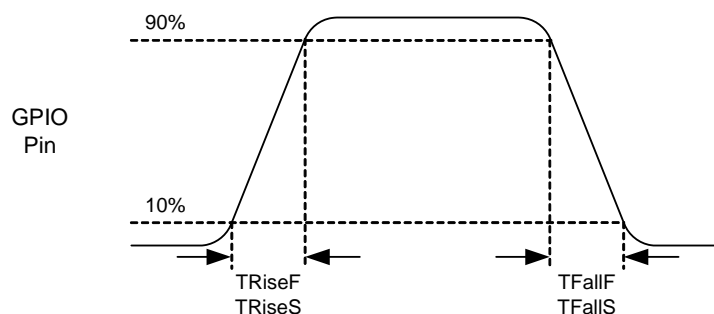


Table 31. 3.3-V AC External Clock Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F _{OSCEXT}	Frequency with CPU clock divide by 1	0.093	–	12.3	MHz	Maximum CPU frequency is 12 MHz at 3.3 V. With the CPU clock divider set to 1, the external clock must adhere to the maximum frequency and duty cycle requirements.
F _{OSCEXT}	Frequency with CPU clock divide by 2 or greater	0.186	–	24.6	MHz	If the frequency of the external clock is greater than 12 MHz, the CPU clock divider must be set to 2 or greater. In this case, the CPU clock divider will ensure that the fifty percent duty cycle requirement is met.
–	High period with CPU clock divide by 1	41.7	–	5300	ns	
–	Low period with CPU clock divide by 1	41.7	–	–	ns	
–	Power up IMO to switch	150	–	–	μs	

Table 32. 2.7-V AC External Clock Specifications

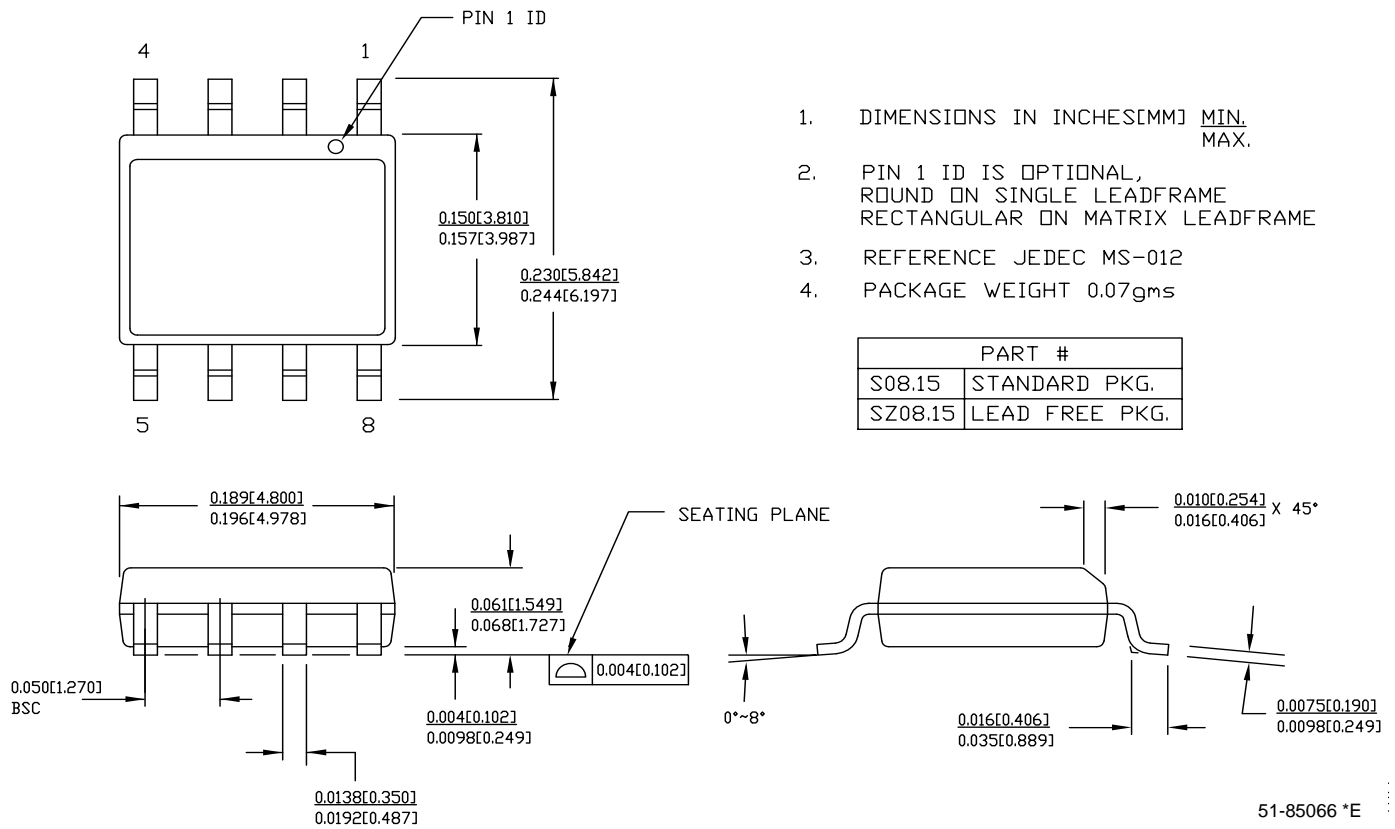
Symbol	Description	Min	Typ	Max	Units	Notes
F _{OSCEXT}	Frequency with CPU clock divide by 1	0.093	–	6.06	MHz	Maximum CPU frequency is 3 MHz at 2.7 V. With the CPU clock divider set to 1, the external clock must adhere to the maximum frequency and duty cycle requirements.
F _{OSCEXT}	Frequency with CPU clock divide by 2 or greater	0.186	–	12.12	MHz	If the frequency of the external clock is greater than 3 MHz, the CPU clock divider must be set to 2 or greater. In this case, the CPU clock divider will ensure that the fifty percent duty cycle requirement is met.
–	High period with CPU clock divide by 1	83.4	–	5300	ns	
–	Low period with CPU clock divide by 1	83.4	–	–	ns	
–	Power up IMO to switch	150	–	–	μs	

Packaging Information

This section illustrates the packaging specifications for the CY8CLED02 EZ-Color device, along with the thermal impedances for each package and minimum solder reflow peak temperature.

Important Note Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the emulator pod drawings at <http://www.cypress.com>.

Figure 10. 8-Pin (150-Mil) SOIC



Development Tool Selection

This section presents the development tools available for all current PSoC based devices including the CY8CLED02 EZ-Color family.

Software Tools

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer, used to generate PSoC firmware applications. PSoC Designer is available free of charge at <http://www.cypress.com> and includes a free C compiler.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube in-circuit emulator and PSoC MiniProg. PSoC programmer is available free of charge at <http://www.cypress.com>.

Hardware Tools

In-Circuit Emulator

A low cost, high functionality in-circuit emulator (ICE)) is available for development support. This hardware has the capability to program single devices.

The emulator consists of a base unit that connects to the PC by way of the USB port. The base unit is universal and will operate with all PSoC based devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the device on the target board and performs full speed (24 MHz) operation.

I²C to USB Bridge

The I²C to USB Bridge is a quick and easy link from any design or application's I²C bus to a PC via USB for design testing, debugging and communication.

Evaluation Tools

All evaluation tools can be purchased from the Cypress Online Store.

CY3210-MiniProg1

The [CY3210-MiniProg1](#) kit allows you to program PSoC based devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg programming unit
- MiniEval socket programming and evaluation board
- 28-Pin CY8C29466-24PXI PDIP PSoC device sample

- 28-Pin CY8C27443-24PXI PDIP PSoC device sample
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable

CY3210-PSoCEval1

The [CY3210-PSoCEval1](#) kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, and plenty of breadboarding space to meet all of your evaluation needs. The kit includes:

- Evaluation board with LCD module
- MiniProg programming unit
- 28-Pin CY8C29466-24PXI PDIP PSoC device sample (2)
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable

Device Programmers

All device programmers are sold at the Cypress Online Store.

CY3216 Modular Programmer

The [CY3216 Modular Programmer](#) kit features a modular programmer and the MiniProg1 programming unit. The modular programmer includes three programming module cards and supports multiple Cypress products. The kit includes:

- Modular programmer base
- Three programming module cards
- MiniProg Programming Unit
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable

CY3207ISSP In-System Serial Programmer (ISSP)

The [CY3207ISSP](#) is a production programmer. It includes protection circuitry and an industrial case that is more robust than the MiniProg in a production-programming environment.

Note CY3207ISSP needs special software and is not compatible with PSoC Programmer. The kit includes:

- CY3207 programmer unit
- PSoC ISSP software CD
- 110 ~ 240 V power supply, Euro-Plug adapter
- USB 2.0 cable

Accessories (Emulation and Programming)

Table 38. Emulation and Programming Accessories

Part #	Pin Package	Flex-Pod Kit ^[23]	Foot Kit ^[24]	Adapter ^[25]
CY8CLED02-16SXI	16-pin SOIC	CY3250-LED02	CY3250-16SOIC-FK	Adapters can be found at http://www.emulation.com .
CY8CLED02-24LFXI	24-pin QFN	CY3250-LED02QFN	CY3250-24QFN-FK	

Ordering Information

Key Device Features

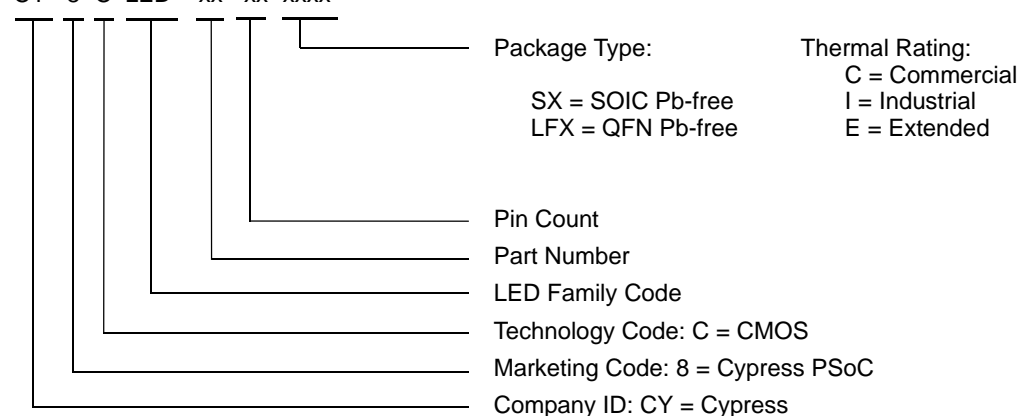
The following table lists the CY8CLED02 EZ-Color devices' key package features and ordering codes.

Table 39. Device Key Features and Ordering Information

Package	Ordering Code	Flash (Bytes)	RAM (Bytes)	Switch Mode Pump	Temperature Range	Digital Blocks	Analog Blocks	Digital I/O Pins	Analog Inputs	Analog Outputs	XRES Pin
16-Pin (150-Mil) SOIC	CY8CLED02-16SXI	4 K	256	Yes	–40 °C to +85 °C	4	4	12	8	0	No
16-Pin (150-Mil) SOIC (Tape and Reel)	CY8CLED02-16SXIT	4 K	256	Yes	–40 °C to +85 °C	4	4	12	8	0	No
24-Pin (4x4) QFN	CY8CLED02-24LFXI	4 K	256	Yes	–40 °C to +85 °C	4	4	16	8	0	Yes
24-Pin (4x4) QFN (Tape and Reel)	CY8CLED02-24LFXIT	4 K	256	Yes	–40 °C to +85 °C	4	4	16	8	0	Yes

Ordering Code Definitions

CY 8 C LED xx - xx xxxx



Notes

23. Flex-Pod kit includes a practice flex-pod and a practice PCB, in addition to two flex-pods.

24. Foot kit includes surface mount feet that can be soldered to the target PCB.

25. Programming adapter converts non-DIP package to DIP footprint. Specific details and ordering information for each of the adapters can be found at <http://www.emulation.com>.

Acronyms

Table 40 lists the acronyms that are used in this document.

Table 40. Acronyms Used in this Datasheet

Acronym	Description	Acronym	Description
AC	alternating current	LPC	low power comparator
ADC	analog-to-digital converter	MIPS	million instructions per second
API	application programming interface	PCB	printed circuit board
CMOS	complementary metal oxide semiconductor	PDIP	plastic dual-in-line package
CPU	central processing unit	POR	power-on reset
CRC	cyclic redundancy check	PPOR	precision power on reset
CT	continuous time	PRS	pseudo-random sequence
DAC	digital-to-analog converter	PSoC®	Programmable System-on-Chip
DC	direct current	PWM	pulse-width modulator
EEPROM	electrically erasable programmable read-only memory	QFN	quad flat no leads
GPIO	general purpose I/O	SC	switched capacitor
I/O	input/output	SRAM	static random access memory
ICE	in-circuit emulator	SLIMO	slow IMO
IDE	integrated development environment	SMP	switch mode pump
ILO	internal low speed oscillator	SOIC	small-outline integrated circuit
IMO	internal main oscillator	SPI™	serial peripheral interface
IrDA	infrared data association	SROM	supervisory read only memory
ISSP	in-system serial programming	UART	universal asynchronous receiver / transmitter
LCD	liquid crystal display	USB	universal serial bus
LED	light-emitting diode	XRES	external reset
LVD	low-voltage detect	WDT	watchdog timer

Reference Documents

Design Aids – Reading and Writing PSoC® Flash – AN2015 (001-40459)

Understanding Datasheet Jitter Specifications for Cypress Timing Products – AN5054 (001-14503)

Application Notes for Surface Mount Assembly of Amkor's MicroLeadFrame (MLF) Packages – available at <http://www.amkor.com>.

Document Conventions

Units of Measure

Table 41 lists the units of measure.

Table 41. Units of Measure

Symbol	Unit of Measure	Symbol	Unit of Measure
°C	degree Celsius	μs	microsecond
dB	decibels	μH	micro henry
kHz	kilohertz	ps	picosecond
kΩ	kilo ohm	mV	millivolt
mA	milliamper	V	volt
mH	millihenry	%	percent
MHz	megahertz	μV	microvolt
nA	nano ampere	W	watt
pA	pico ampere	mm	millimeter
pF	picofarad	ns	nanosecond
μA	microampere	mVpp	millivolts peak-to-peak
μF	microfarad	ms	millisecond

Numeric Conventions

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (for example, '01010100b' or '01000011b'). Numbers not indicated by an 'h' or 'b' are decimals.

Glossary

active high	<ol style="list-style-type: none"> 1. A logic signal having its asserted state as the logic 1 state. 2. A logic signal having the logic 1 state as the higher voltage of the two states.
analog blocks	The basic programmable opamp circuits. These are switched capacitor (SC) and continuous time (CT) blocks. These blocks can be interconnected to provide ADCs, DACs, multi-pole filters, gain stages, and much more.
analog-to-digital (ADC)	A device that changes an analog signal to a digital signal of corresponding magnitude. Typically, an ADC converts a voltage to a digital number. The digital-to-analog (DAC) converter performs the reverse operation.
Application programming interface (API)	<p>A series of software routines that comprise an interface between a computer application and lower level services and functions (for example, user modules and libraries).</p> <p>APIs serve as building blocks for programmers that create software applications.</p>
asynchronous	A signal whose data is acknowledged or acted upon immediately, irrespective of any clock signal.
bandgap reference	A stable voltage reference design that matches the positive temperature coefficient of VT with the negative temperature coefficient of VBE, to produce a zero temperature coefficient (ideally) reference.
bandwidth	<ol style="list-style-type: none"> 1. The frequency range of a message or information processing system measured in hertz. 2. The width of the spectral region over which an amplifier (or absorber) has substantial gain (or loss); it is sometimes represented more specifically as, for example, full width at half maximum.

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